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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	72MHz
Connectivity	I <sup>2</sup> C, IrDA, LINbus, PMP, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, HLVD, I2S, POR, PWM, WDT
Number of I/O	34
Program Memory Size	128KB (128K x 8)
rogram Memory Type	FLASH
EPROM Size	-
RAM Size	32K x 8
/oltage - Supply (Vcc/Vdd)	2.5V ~ 3.6V
Oata Converters	A/D 13x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VQFN Exposed Pad
Supplier Device Package	44-QFN (8x8)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx154f128d-v-ml

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

### TABLE 6: PIN NAMES FOR 28-PIN USB DEVICES WITHOUT VBAT

28-PIN SOIC (TOP VIEW)(1,2,3)

28

SOIC

PIC32MX254F128B PIC32MX274F256B

Pin#	Full Pin Name
1	MCLR
2	PGED3/VREF+/AN0/C3INC/RPA0/ASDA1/CTED1/PMD7/RA0
3	PGEC3/VREF-/AN1/RPA1/ASCL1/CTED2/PMD6/RA1
4	PGED2/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0
5	PGEC2/AN3/C1INC/C2INA/LVDIN/RPB1/CTED12/PMD1//RB1
6	PGED1/AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2
7	PGEC1/AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3
8	Vss
9	OSC1/CLKI/RPA2/RA2
10	OSC2/CLKO/RPA3/PMA0/RA3
11	SOSCI/RPB4/CTED11/RB4 <sup>(4)</sup>
12	SOSCO/RPA4/T1CK/CTED9/RA4
13	VDD
14	TMS/RPB5/USBID/RB5

Pin#	Full Pin Name
15	VBUS
16	TDI/RPB7/CTED3/PMD5/INT0/RB7
17	TCK/RPB8/SCL1/CTED10/PMD4/RB8
18	TDO/RPB9/SDA1/CTED4/PMD3/RB9
19	Vss
20	VCAP
21	D+
22	D-
23	Vusb3v3
24	AN11/RPB13/CTPLS/PMRD/RB13
25	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMA1/RB14
26	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
27	AVss
28	AVDD

Note

- 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and 12.3 "Peripheral Pin Select" for restrictions
- 2: Every I/O port pin (RAx-RBx) can be used as a change notification pin (CNAx-CNBx). See 12.0 "I/O Ports" for more information.
- 3: Shaded pins are 5V tolerant.
- 4: This is an input-only pin.

### TABLE 7: PIN NAMES FOR 28-PIN GENERAL PURPOSE DEVICES WITH VBAT

28-PIN QFN (TOP VIEW)(1,2,3.4)

PIC32MX155F128D PIC32MX175F256D

28

1

Pin#	Full Pin Name
1	PGED2/AN2/C1IND/C2INB/C3IND/RPB0/RB0
2	PGEC2/AN3/C1INC/C2INA/LVDIN/RPB1/CTED12/RB1
3	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2
4	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/CTPLS/RB3
5	Vss
6	OSC1/CLKI/RPA2/RA2
7	OSC2/CLKO/RPA3/PMA0/RA3
8	SOSCI/RPB4/RB4 <sup>(5)</sup>
9	SOSCO/RPA4/T1CK/CTED9/RA4
10	VDD
11	PGED3/RPB5/ASDA2/PMD7/RB5
12	PGEC3/RPB6/ASCL2/PMD6/RB6
13	TDI/RPB7/CTED3/PMD5/INT0/RB7
14	TCK/RPB8/SCL1/CTED10/PMD4/RB8

Pin#	Full Pin Name
15	TDO/RPB9/SDA1/CTED4/PMD3/RB9
16	Vss
17	VCAP
18	PGED1/RPB10/CTED11/PMD2/RB10
19	PGEC1/TMS/RPB11/PMD1/RB11
20	AN12/PMD0/RB12
21	VBAT
22	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14
23	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
24	AVss
25	AVDD
26	MCLR
27	VREF+/AN0/C3INC/RPA0ASDA1//CTED1/PMA1/RA0
28	VREF-/AN1/RPA1/ASCL1/CTED2/PMRD/RA1

Note

- 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and 12.3 "Peripheral Pin Select" for restrictions
- 2: Every I/O port pin (RAx-RBx) can be used as a change notification pin (CNAx-CNBx). See 12.0 "I/O Ports" for more information.
- 3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.
- 4: Shaded pins are 5V tolerant.
- 5: This is an input-only pin.

**TABLE 1-11: COMPARATOR 1, COMPARATOR 2, AND COMPARATOR VOLTAGE REFERENCE PINOUT I/O DESCRIPTIONS** 

	Pi	in Number	(1)			
Pin Name	28-pin QFN	28-pin QFN/ SOIC TQFP		Pin Buffer Type Type		Description
			Co	mparate	or Voltage	Reference
VREF-	28	3	20	I	Analog	Comparator Voltage Reference (Low)
VREF+	27	2	19	I	Analog	Comparator Voltage Reference (High)
CVREFOUT	22	25	14	0	Analog	Comparator Voltage Reference Output
				С	omparator	1
C1INA	4	7	24	I	Analog	Comparator 1 Positive Input
C1INB	3	6	23	I	Analog	Comparator 1 Selectable Negative Input
C1INC	2	5	22	I	Analog	
C1IND	1	4	21	I	Analog	
C1OUT	PPS	PPS	PPS	0	_	Comparator 1 Output
				С	omparator	2
C2INA	2	5	22	I	Analog	Comparator 2 Positive Input
C2INB	1	4	21	I	Analog	Comparator 2 Selectable Negative Input
C2INC	4	7	24	I	Analog	
C2IND	3	6	23	I	Analog	
C2OUT	PPS	PPS	PPS	0	_	Comparator 2 Output
				С	omparator	3
C3INA	23	26	15	I	Analog	Comparator 3 Positive Input
C3INB	22	25	14	I	Analog	Comparator 3 Selectable Negative Input
C3INC	27	2	19	ı	Analog	
C3IND	1	4	21	I	Analog	
C3OUT	PPS	PPS	PPS	0		Comparator 3 Output

**Legend:** CMOS = CMOS compatible input or output

TTL = TTL input buffer

ST = Schmitt Trigger input with CMOS levels

Analog = Analog input

O = OutputPPS = Peripheral Pin Select P = Power I=Input --=N/A

Note 1: Pin numbers are provided for reference only. See the "Pin Diagrams" section for device pin availability.

TABLE 7-1: INTERRUPT IRQ, VECTOR AND BIT LOCATION

Interrupt Source <sup>(1)</sup>	IRQ	Vector		Persistent			
interrupt Source(*)	#	#	Flag	Enable	Priority	Sub-priority	Interrupt
		Highes	st Natural C	rder Priority	,		•
CT – Core Timer Interrupt	0	0	IFS0<0>	IEC0<0>	IPC0<4:2>	IPC0<1:0>	No
CS0 – Core Software Interrupt 0	1	1	IFS0<1>	IEC0<1>	IPC0<12:10>	IPC0<9:8>	No
CS1 – Core Software Interrupt 1	2	2	IFS0<2>	IEC0<2>	IPC0<20:18>	IPC0<17:16>	No
INT0 – External Interrupt	3	3	IFS0<3>	IEC0<3>	IPC0<28:26>	IPC0<25:24>	No
T1 – Timer1	4	4	IFS0<4>	IEC0<4>	IPC1<4:2>	IPC1<1:0>	No
IC1E - Input Capture 1 Error	5	5	IFS0<5>	IEC0<5>	IPC1<12:10>	IPC1<9:8>	Yes
IC1 – Input Capture 1	6	5	IFS0<6>	IEC0<6>	IPC1<12:10>	IPC1<9:8>	Yes
OC1 – Output Compare 1	7	6	IFS0<7>	IEC0<7>	IPC1<20:18>	IPC1<17:16>	No
INT1 – External Interrupt 1	8	7	IFS0<8>	IEC0<8>	IPC1<28:26>	IPC1<25:24>	No
T2 – Timer2	9	8	IFS0<9>	IEC0<9>	IPC2<4:2>	IPC2<1:0>	No
IC2E - Input Capture 2	10	9	IFS0<10>	IEC0<10>	IPC2<12:10>	IPC2<9:8>	Yes
IC2 – Input Capture 2	11	9	IFS0<11>	IEC0<11>	IPC2<12:10>	IPC2<9:8>	Yes
OC2 – Output Compare 2	12	10	IFS0<12>	IEC0<12>	IPC2<20:18>	IPC2<17:16>	No
INT2 – External Interrupt 2	13	11	IFS0<13>	IEC0<13>	IPC2<28:26>	IPC2<25:24>	No
T3 – Timer3	14	12	IFS0<14>	IEC0<14>	IPC3<4:2>	IPC3<1:0>	No
IC3E - Input Capture 3	15	13	IFS0<15>	IEC0<15>	IPC3<12:10>	IPC3<9:8>	Yes
IC3 – Input Capture 3	16	13	IFS0<16>	IEC0<16>	IPC3<12:10>	IPC3<9:8>	Yes
OC3 – Output Compare 3	17	14	IFS0<17>	IEC0<17>	IPC3<20:18>	IPC3<17:16>	No
INT3 – External Interrupt 3	18	15	IFS0<18>	IEC0<18>	IPC3<28:26>	IPC3<25:24>	No
T4 – Timer4	19	16	IFS0<19>	IEC0<19>	IPC4<4:2>	IPC4<1:0>	No
IC4E – Input Capture 4 Error	20	17	IFS0<20>	IEC0<20>	IPC4<12:10>	IPC4<9:8>	Yes
IC4 – Input Capture 4	21	17	IFS0<21>	IEC0<21>	IPC4<12:10>	IPC4<9:8>	Yes
OC4 – Output Compare 4	22	18	IFS0<22>	IEC0<22>	IPC4<20:18>	IPC4<17:16>	No
INT4 – External Interrupt 4	23	19	IFS0<23>	IEC0<23>	IPC4<28:26>	IPC4<25:24>	No
T5 – Timer5	24	20	IFS0<24>	IEC0<24>	IPC5<4:2>	IPC5<1:0>	No
IC5E - Input Capture 5 Error	25	21	IFS0<25>	IEC0<25>	IPC5<12:10>	IPC5<9:8>	Yes
IC5 – Input Capture 5	26	21	IFS0<26>	IEC0<26>	IPC5<12:10>	IPC5<9:8>	Yes
OC5 – Output Compare 5	27	22	IFS0<27>	IEC0<27>	IPC5<20:18>	IPC5<17:16>	No
AD1 – ADC1 Convert done	28	23	IFS0<28>	IEC0<28>	IPC5<28:26>	IPC5<25:24>	Yes
FSCM – Fail-Safe Clock Monitor	29	24	IFS0<29>	IEC0<29>	IPC6<4:2>	IPC6<1:0>	No
RTCC – Real-Time Clock and Calendar	30	25	IFS0<30>	IEC0<30>	IPC6<12:10>	IPC6<9:8>	No
FCE - Flash Control Event	31	26	IFS0<31>	IEC0<31>	IPC6<20:18>	IPC6<17:16>	No
CMP1 – Comparator Interrupt	32	27	IFS1<0>	IEC1<0>	IPC6<28:26>	IPC6<25:24>	No
CMP2 – Comparator Interrupt	33	28	IFS1<1>	IEC1<1>	IPC7<4:2>	IPC7<1:0>	No
CMP3 – Comparator Interrupt	34	29	IFS1<2>	IEC1<2>	IPC7<12:10>	IPC7<9:8>	No
USB – USB Interrupts	35	30	IFS1<3>	IEC1<3>	IPC7<20:18>	IPC7<17:16>	Yes
SPI1E - SPI1 Fault	36	31	IFS1<4>	IEC1<4>	IPC7<28:26>	IPC7<25:24>	Yes
SPI1RX – SPI1 Receive Done	37	31	IFS1<5>	IEC1<5>	IPC7<28:26>	IPC7<25:24>	Yes
SPI1TX - SPI1 Transfer Done	38	31	IFS1<6>	IEC1<6>	IPC7<28:26>	IPC7<25:24>	Yes

Note 1: Not all interrupt sources are available on all devices. See TABLE 1: "PIC32MX1XX 28/44-Pin XLP (General Purpose) Family Features" and TABLE 2: "PIC32MX2XX 28/44-Pin XLP (USB) Family Features" for the lists of available peripherals.

#### REGISTER 11-1: U10TGIR: USB OTG INTERRUPT STATUS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	-	-	-	_	-	_	-	_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	_	-	_	_	_	_	_	_
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
13.6	_	-	_	_	_	_	_	_
7.0	R/WC-0, HS	U-0	R/WC-0, HS					
7:0	IDIF	T1MSECIF	LSTATEIF	ACTVIF	SESVDIF	SESENDIF	_	VBUSVDIF

**Legend:** WC = Write '1' to clear HS = Hardware Settable bit

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

bit 7 IDIF: ID State Change Indicator bit

1 = A change in the ID state was detected0 = No change in the ID state was detected

bit 6 T1MSECIF: 1 Millisecond Timer bit

1 = 1 millisecond timer has expired0 = 1 millisecond timer has not expired

bit 5 LSTATEIF: Line State Stable Indicator bit

1 = USB line state has been stable for 1 ms, but different from last time

0 = USB line state has not been stable for 1 ms

bit 4 ACTVIF: Bus Activity Indicator bit

1 = Activity on the D+, D-, ID or VBUS pins has caused the device to wake-up

0 = Activity has not been detected

bit 3 **SESVDIF:** Session Valid Change Indicator bit

1 = VBUS voltage has dropped below the session end level

0 = VBUS voltage has not dropped below the session end level

bit 2 SESENDIF: B-Device VBUS Change Indicator bit

1 = A change on the session end input was detected

0 = No change on the session end input was detected

bit 1 Unimplemented: Read as '0'

bit 0 VBUSVDIF: A-Device VBUS Change Indicator bit

1 = A change on the session valid input was detected

0 = No change on the session valid input was detected

**TABLE 12-4: PORTB REGISTER MAP** 

ess										Bits									
Virtual Address (BF88_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
6100	ANSELB	31:16	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	0000
0100	ANOLLD	15:0	ANSB15	ANSB14	ANSB13 <sup>(3)</sup>	ANSB12 <sup>(2)</sup>	_	_	_	_	_	_	_	_	ANSB3	ANSB2	ANSB1	ANSB0	EOOF
6110	TRISB	31:16	_	-	_	_	_	_	_	_	-	_	_	_	_	_	_	_	0000
00		15:0	TRISB15	TRISB14	TRISB13 <sup>(3)</sup>	TRISB12 <sup>(2)</sup>	TRISB11 <sup>(2)</sup>	TRISB10 <sup>(2)</sup>	TRISB9	TRISB8	TRISB7	TRISB6 <sup>(2)</sup>	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	FFFF
6120	PORTB	31:16	_	_	<u> </u>		<u> </u>	<u> </u>	_	_	_		_						0000
		15:0	RB15	RB14	RB13 <sup>(3)</sup>	RB12 <sup>(2)</sup>	RB11 <sup>(2)</sup>	RB10 <sup>(2)</sup>	RB9	RB8	RB7	RC6 <sup>(2)</sup>	RB5	RB4	RB3	RB2	RB1	RB0	XXXX
6130	LATB	31:16	_	_	— (a)				_	_	_		_		_	_	_	_	0000
		15:0	LATB15	LATB14	LATB13 <sup>(3)</sup>	LATB12 <sup>(2)</sup>	LATB11 <sup>(2)</sup>	LATB10 <sup>(2)</sup>	LATB9	LATB8	LATB7	LATB6 <sup>(2)</sup>	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	XXXX
6140	ODCB	31:16	_	_	— (a)				_	_	_	_	_		_	_	_	_	0000
0.10		15:0	ODCB15	ODCB14	ODCB13 <sup>(3)</sup>	ODCB12 <sup>(2)</sup>	ODCB11 <sup>(2)</sup>	ODCB10 <sup>(2)</sup>	ODCB9	ODCB8	ODCB7	ODCB6	ODCB5	ODCB4	ODCB3	ODCB2	ODCB1	ODCB0	0000
6150	CNPUB	31:16	_	_	— (a)				_	_	_		_		_	_	_	_	0000
0.00			CNPUB15	CNPUB14	CNPUB13(3)	CNPUB12 <sup>(2)</sup>	CNPUB11(2)	CNPUB10(2)	CNPUB9	CNPUB8	CNPUB7	CNPUB6 <sup>(2)</sup>	CNPUB5	CNPUB4	CNPUB3	CNPUB2	CNPUB1	CNPUB0	
6160	CNPDB	31:16	_	_	_				_	_	_		_		_	_	_	_	0000
0.00			CNPDB15	CNPDB14	CNPDB13	CNPDB12 <sup>(2)</sup>	CNPDB11(2)	CNPDB10(2)	CNPDB9	CNPDB8	CNPDB7	CNPDB6 <sup>(2)</sup>	CNPDB5	CNPDB4	CNPDB3	CNPDB2	CNPDB1	CNPDB0	
6170	CNCONB	31:16	_	_	_		_	_	_	_	_	_	_	_	_	_	_	_	0000
		15:0	ON	_	SIDL		_	_	_	_	_	_	_	_	_	_	_	_	0000
6180	CNENB	31:16		_	— (2)	— (2)	— (2)	— (2)		_		— (2)				_			0000
		15:0	CNIEB15	CNIEB14	CNIEB13 <sup>(3)</sup>	CNIEB11 <sup>(2)</sup>	CNIEB11 <sup>(2)</sup>	CNIEB10 <sup>(2)</sup>	CNIEB9	CNIEB8	CNIEB7	CNIEB6 <sup>(2)</sup>	CNIEB5	CNIEB4	CNIEB3	CNIEB2	CNIEB1		0000
		31:16	_		_	_	_	_		_	_	_				_	_		0000
6190	CNSTATB	15:0	CN STATB15	CN STATB14	CN STATB13 <sup>(3)</sup>	CN STATB12 <sup>(2)</sup>	CN STATB11 <sup>(2)</sup>	CN STATB10 <sup>(2)</sup>	CN STATB9	CN STATB8	CN STATB7	CN STATB6 <sup>(2)</sup>	CN STATB5	CN STATB4	CN STATB3	CN STATB2	CN STATB1	CN STATB0	0000

**Legend:** x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See 12.2 "CLR, SET and INV Registers" for more information.

- 2: This bit is not available on USB devices.
- 3: This bit is not available on VBAT devices.

### REGISTER 13-1: T1CON: TYPE A TIMER CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	-	_	-	-	-	-	_	-
22.16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	-	_			-	-	_	-
15.0	R/W-0	U-0	R/W-0	R/W-0	R-0	U-0	R/W-0	R/W-0
15:8	ON <sup>(1)</sup>	_	SIDL	TWDIS	TWIP	_	TECS	S<1:0>
7:0	R/W-0	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	U-0
7.0	TGATE	_	TCKPS	S<1:0>	_	TSYNC	TCS	_

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15 **ON:** Timer On bit<sup>(1)</sup>

1 = Timer is enabled

0 = Timer is disabled

bit 14 Unimplemented: Read as '0'

bit 13 SIDL: Stop in Idle Mode bit

1 = Discontinue module operation when the device enters Idle mode

0 = Continue module operation when the device enters Idle mode

bit 12 TWDIS: Asynchronous Timer Write Disable bit

1 = Writes to Timer1 are ignored until pending write operation completes

0 = Back-to-back writes are enabled (Legacy Asynchronous Timer functionality)

bit 11 **TWIP:** Asynchronous Timer Write in Progress bit

In Asynchronous Timer mode:

1 = Asynchronous write to the Timer1 register in progress

0 = Asynchronous write to Timer1 register is complete

In Synchronous Timer mode:

This bit is read as '0'.

bit 10 Unimplemented: Read as '0'

bit 9-8 TECS<1:0>: Timer1 External Clock Selection bits

11 = Reserved

10 = External clock comes from the LPRC

01 = External clock comes from the T1CK pin

00 = External clock comes from the Sosc

bit 7 **TGATE:** Timer Gated Time Accumulation Enable bit

When TCS = 1:

This bit is ignored.

When TCS = 0:

1 = Gated time accumulation is enabled

0 = Gated time accumulation is disabled

bit 6 Unimplemented: Read as '0'

**Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

**NOTES:** 

**NOTES:** 

### 21.1 UART Control Registers

### TABLE 21-1: UART1 AND UART2 REGISTER MAP

ess										Ві	its								"
Virtual Address (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
6000	U1MODE <sup>(1)</sup>	31:16 — —				1	_	_		_	SLPEN	ACTIVE		1	_	CLKSE	L<1:0>	RUNOVF	0000
0000	OTWODE	15:0	ON	-	SIDL	IREN	RTSMD	_	UEN-	<1:0>	WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSE	L<1:0>	STSEL	0000
6010	U1STA <sup>(1)</sup>	31:16				MASK	<7:0>							ADDR	?<7:0>				0000
0010	UISIA	15:0	UTXISE	L<1:0>	UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT	URXISE	EL<1:0>	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
6020	U1TXREG	31:16	_	_	_	-	_	_	1	_	_	_	_	1	_	_	_	_	0000
0020	OTTAINEO	15:0	_	1	1	1	_	_	1	TX8				Transmit	Register				0000
6030	U1RXREG	31:16		_	_	-	_	_	1	_	_	_	_	1	_	_	_	_	0000
0030	OTIVALLO	15:0	_	-	-	1	_	_	I	RX8				Receive	Register				0000
6040	U1BRG <sup>(1)</sup>	31:16	_	1	1	1	_	_	1	1	_	_	1	1	_	_	_	_	0000
0040	OTDINO	15:0							Bau	d Rate Gen	erator Pres	caler							0000
6200	U2MODE <sup>(1)</sup>	31:16	_	_	_	_	-	_	_	_	SLPEN	ACTIVE	_	_	_	CLKSE	L<1:0>	RUNOVF	0000
0200	UZIVIODE. 1	15:0	ON	_	SIDL	IREN	RTSMD	-	UEN-	<1:0>	WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSE	L<1:0>	STSEL	0000
6210	U2STA <sup>(1)</sup>	31:16				MASK	<7:0>							ADDR	?<7:0>				0000
0210	0231A	15:0	UTXISE	L<1:0>	UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT	URXISE	EL<1:0>	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
6220	U2TXREG	31:16	_	_	_	1	_	-	_	_	_	_	_	_	_	_	_	_	0000
0220	UZIAREG	15:0	_	_		-	_	-	_	TX8				Transmit	Register				0000
6230	U2RXREG	31:16	_	1		1	_		I	-	_	_		1	_	_	_	_	0000
0230	UZKAKLG	15:0	_	-	1	1	_		1	RX8				Receive	Register				0000
6240	U2BRG <sup>(1)</sup>	31:16	_	_	_		_	_	_	_	_	_	_		_	_	_	_	0000
0240	OZDRG"	15:0	•			•			Bau	d Rate Gen	erator Pres	caler					•		0000

**Legend:** x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: This register has corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See 12.2 "CLR, SET and INV Registers" for more information.

**NOTES:** 

### REGISTER 22-7: PMRADDR: PARALLEL PORT READ ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
24.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
31:24			_	_	_	_	_	_		
22.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
23:16	_	_	_	_	_	_	_	_		
45.0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0		
15:8	_	RCS1	_	_	_	RADDR<10:8>				
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
	RADDR<7:0>									

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-15 Unimplemented: Read as '0'

bit 14 RCS1: Chip Select 1 bit

1 = Chip Select 1 is active

0 = Chip Select 1 is inactive (RADDR14 function is selected)

bit 13-11 **Unimplemented:** Read as '0' bit 10-0 **RADDR<13:0>:** Address bits

**Note:** This register is only used when the DUALBUF bit (PMCON<17>) is set to '1'.

### REGISTER 24-3: AD1CON3: ADC CONTROL REGISTER 3

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
	_	_	_	_	_	_	_	_	
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
	_	_	_	_	_	_	_	_	
15:8	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
	ADRC	_	_	SAMC<4:0> <sup>(1)</sup>					
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W	R/W-0	
	ADCS<7:0> <sup>(2)</sup>								

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15 ADRC: ADC Conversion Clock Source bit

1 = Clock derived from FRC

0 = Clock derived from Peripheral Bus Clock (PBCLK)

bit 14-13 Unimplemented: Read as '0'

bit 12-8 **SAMC<4:0>:** Auto-Sample Time bits<sup>(1)</sup>

11111 = **31** TAD

•

•

00001 = 1 TAD

00000 = 0 TAD (Not allowed)

bit 7-0 ADCS<7:0>: ADC Conversion Clock Select bits<sup>(2)</sup>

11111111 = TPB • 2 • (ADCS<7:0> + 1) = 512 • TPB = TAD

•

•

•

00000001 =TPB • 2 • (ADCS<7:0> + 1) = 4 • TPB = TAD 00000000 =TPB • 2 • (ADCS<7:0> + 1) = 2 • TPB = TAD

**Note 1:** This bit is only used if the SSRC<2:0> bits (AD1CON1<7:5>) = 111.

2: This bit is not used if the ADRC (AD1CON3<15>) bit = 1.

### 29.0 POWER-SAVING FEATURES

Note:

This data sheet summarizes the features of the PIC32MX1XX/2XX 28/44-pin XLP Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 10. "Power-Saving Features" (DS60001130), which is available from the Documentation > Reference Manual section of the PIC32 Microchip web site (www.microchip.com/pic32).

This section describes power-saving features for the PIC32MX1XX/2XX 28/44-pin XLP Family. The PIC32 devices offer a total of nine methods and modes, organized into two categories, that allow the user to balance power consumption with device performance. In all of the methods and modes described in this section, power-saving is controlled by software.

### 29.1 Power Saving with CPU Running

When the CPU is running, power consumption can be controlled by reducing the CPU clock frequency, lowering the PBCLK and by individually disabling modules. These methods are grouped into the following categories:

- FRC Run mode: the CPU is clocked from the FRC clock source with or without postscalers
- LPRC Run mode: the CPU is clocked from the LPRC clock source
- Sosc Run mode: the CPU is clocked from the Sosc clock source

In addition, the Peripheral Bus Scaling mode is available where peripherals are clocked at the programmable fraction of the CPU clock (SYSCLK).

### 29.2 CPU Halted Methods

The device supports two power-saving modes, Sleep and Idle, both of which Halt the clock to the CPU. These modes operate with all clock sources, as follows:

- Posc Idle mode: the system clock is derived from the Posc. The system clock source continues to operate. Peripherals continue to operate, but can optionally be individually disabled.
- FRC Idle mode: the system clock is derived from the FRC with or without postscalers. Peripherals continue to operate, but can optionally be individually disabled.
- Sosc Idle mode: the system clock is derived from the Sosc. Peripherals continue to operate, but can optionally be individually disabled.

- LPRC Idle mode: the system clock is derived from the LPRC. Peripherals continue to operate, but can optionally be individually disabled. This is the lowest power mode for the device with a clock running.
- Sleep mode: the CPU, the system clock source and any peripherals that operate from the system clock source are Halted. Some peripherals can operate in Sleep using specific clock sources. This is the lowest power mode for the device.

### 29.3 Power-Saving Operation

Peripherals and the CPU can be Halted or disabled to further reduce power consumption.

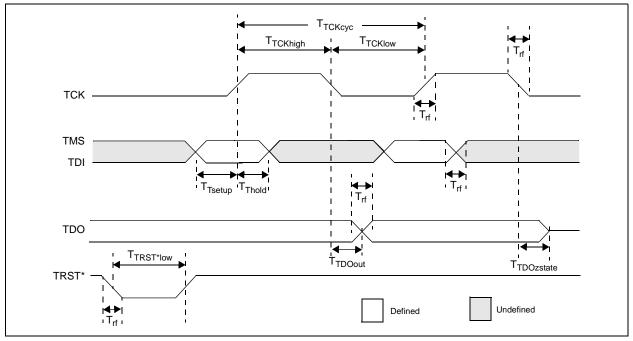
### 29.3.1 SLEEP MODE

Sleep mode has the lowest power consumption of the device power-saving operating modes. The CPU and most peripherals are Halted. Select peripherals can continue to operate in Sleep mode and can be used to wake the device from Sleep. See the individual peripheral module sections for descriptions of behavior in Sleep.

Sleep mode includes the following characteristics:

- · The CPU is halted
- The system clock source is typically shutdown.
  See 29.3.3 "Peripheral Bus Scaling Method" for specific information.
- There can be a wake-up delay based on the oscillator selection
- The Fail-Safe Clock Monitor (FSCM) does not operate during Sleep mode
- The BOR circuit remains operative during Sleep mode
- The WDT, if enabled, is not automatically cleared prior to entering Sleep mode
- Some peripherals can continue to operate at limited functionality in Sleep mode. These peripherals include I/O pins that detect a change in the input signal, WDT, ADC, UART and peripherals that use an external clock input or the internal LPRC oscillator (e.g., RTCC, Timer1 and Input Capture).
- I/O pins continue to sink or source current in the same manner as they do when the device is not in Sleep
- The USB module can override the disabling of the Posc or FRC. Refer to the USB section for specific details.
- Modules can be individually disabled by software prior to entering Sleep in order to further reduce consumption

FIGURE 33-23: EJTAG TIMING CHARACTERISTICS



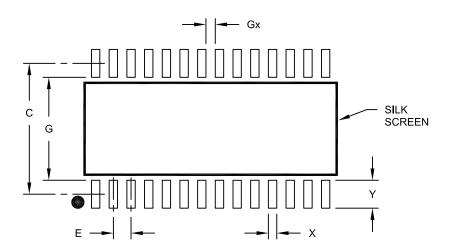
**TABLE 33-43: EJTAG TIMING REQUIREMENTS** 

AC CHARACTERISTICS			(unless	s otherw	ating Co rise state erature	,	
Param. No.	Symbol	Description <sup>(1)</sup>	Min. Max. Units		Units	Conditions	
EJ1	Ттсксүс	TCK Cycle Time	25	_	ns	_	
EJ2	Ттскнідн	TCK High Time	10	_	ns	_	
EJ3	TTCKLOW	TCK Low Time	10	_	ns	_	
EJ4	TTSETUP	TAP Signals Setup Time Before Rising TCK	5	_	ns	_	
EJ5	TTHOLD	TAP Signals Hold Time After Rising TCK	3	_	ns	_	
EJ6	TTDOOUT	TDO Output Delay Time from Falling TCK	_	5	ns	_	
EJ7	TTDOZSTATE	TDO 3-State Delay Time from Falling TCK	_	5	ns	_	
EJ8	TTRSTLOW	TRST Low Time	25	_	ns	_	
EJ9	TRF	TAP Signals Rise/Fall Time, All Input and Output	_	_	ns	_	

Note 1: These parameters are characterized, but not tested in manufacturing.

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



### RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension	MIN	NOM	MAX	
Contact Pitch E		1.27 BSC		
Contact Pad Spacing	C		9.40	
Contact Pad Width (X28)	Х			0.60
Contact Pad Length (X28)	Υ			2.00
Distance Between Pads	Gx	0.67		
Distance Between Pads	G	7.40		·

### Notes:

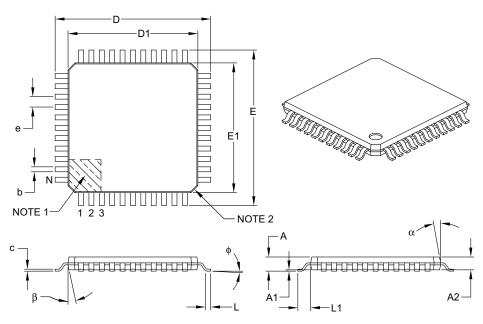
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2052A

### 44-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS				
Dimension Limits		MIN	NOM	MAX	
Number of Leads	N		44		
Lead Pitch	е	0.80 BSC			
Overall Height	А	_	_	1.20	
Molded Package Thickness	A2	0.95	1.00	1.05	
Standoff	A1	0.05	_	0.15	
Foot Length	L	0.45	0.60	0.75	
Footprint L1 1.00		1.00 REF			
Foot Angle	ф	0°	3.5°	7°	
Overall Width	E	12.00 BSC			
Overall Length	D	12.00 BSC			
Molded Package Width	E1	10.00 BSC			
Molded Package Length	D1	10.00 BSC			
Lead Thickness	С	0.09	_	0.20	
Lead Width	b	0.30	0.37	0.45	
Mold Draft Angle Top	α	11°	12°	13°	
Mold Draft Angle Bottom	β	11°	12°	13°	

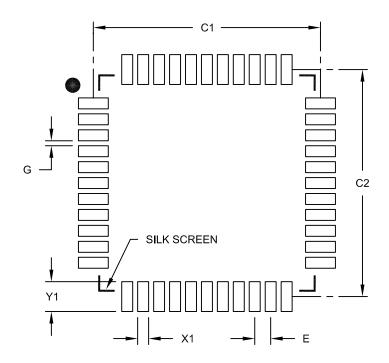
#### Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Chamfers at corners are optional; size may vary.
- 3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
  - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-076B

44-Lead Plastic Thin Quad Flatpack (PT) 10X10X1 mm Body, 2.00 mm Footprint [TQFP]

For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS				
Dimension Limits		MIN	NOM	MAX	
Contact Pitch	Е	0.80 BSC			
Contact Pad Spacing	C1		11.40		
Contact Pad Spacing	C2		11.40		
Contact Pad Width (X44)	X1			0.55	
Contact Pad Length (X44)	Y1			1.50	
Distance Between Pads	G	0.25			

#### Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2076B

**NOTES:** 

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